



Optimum power handling
Low on-state and switching losses
Designed for traction and industrial applications

Phase Control Stud Thyristor

Type T175-320-8

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Maximum allowable mean on-state current	A	320 429	$T_c = 116 ^\circ C$; $T_c = 100 ^\circ C$; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	502	$T_c = 116 ^\circ C$; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	10.5 12.0	$T_j = T_{jmax}$ $T_j = 25 ^\circ C$	180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu s$; $di_G/dt \geq 1$ A/ μs
			11.0 13.0	$T_j = T_{jmax}$ $T_j = 25 ^\circ C$	180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu s$; $di_G/dt \geq 1$ A/ μs
I^2t	Safety factor	$A^2s \cdot 10^3$	550 720	$T_j = T_{jmax}$ $T_j = 25 ^\circ C$	180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu s$; $di_G/dt \geq 1$ A/ μs
			500 700	$T_j = T_{jmax}$ $T_j = 25 ^\circ C$	180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu s$; $di_G/dt \geq 1$ A/ μs
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	100...800	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	200...900	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j = T_{jmax}$; Gate open	

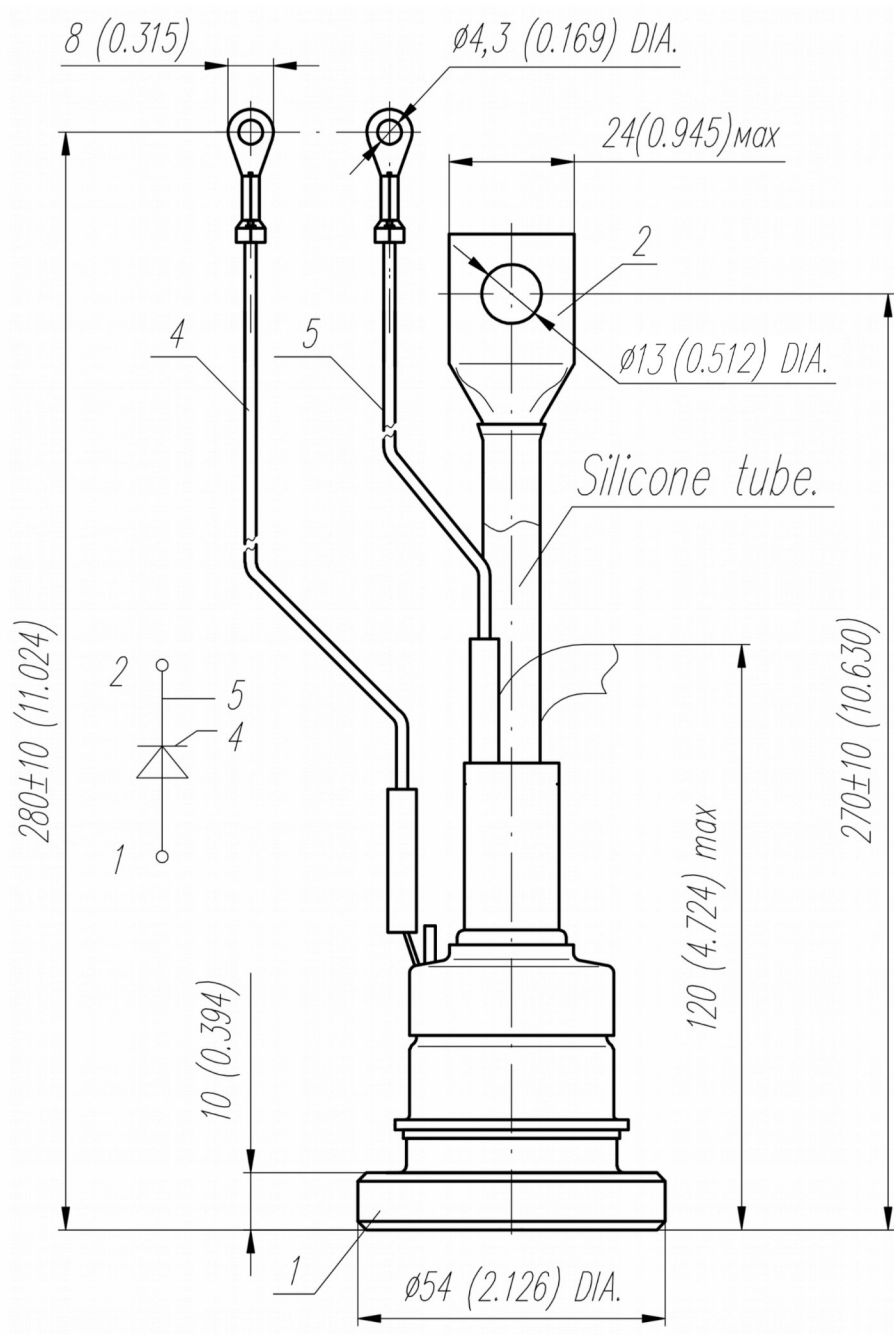
TRIGGERING				
I_{FGM}	Peak forward gate current	A	6	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	3	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1\text{ Hz}$)	A/ μs	800	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 3000\text{ A}$; Gate pulse: $I_G = 2\text{ A}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt \geq 2\text{ A}/\mu\text{s}$
THERMAL				
T_{stg}	Storage temperature	$^{\circ}\text{C}$	$-60...+50$	
T_j	Operating junction temperature	$^{\circ}\text{C}$	$-60...+150$	
MECHANICAL				
F	Mounting force	kN	1.5...2.5	
a	Acceleration	m/s^2	100	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V_{TM}	Peak on-state voltage, max	V	1.35	$T_j = 25\text{ }^{\circ}\text{C}$; $I_{TM} = 1005\text{ A}$		
$V_{T(TO)}$	On-state threshold voltage, max	V	0.871	$T_j = T_{j\max}$; $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$		
r_T	On-state slope resistance, max	$\text{m}\Omega$	0.472			
I_L	Latching current, max	mA	700	$T_j = 25\text{ }^{\circ}\text{C}$; $V_D = 12\text{ V}$; Gate pulse: $I_G = 2\text{ A}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt \geq 1\text{ A}/\mu\text{s}$		
I_H	Holding current, max	mA	300	$T_j = 25\text{ }^{\circ}\text{C}$; $V_D = 12\text{ V}$; Gate open		
BLOCKING						
I_{DRM} , I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	$T_j = T_{j\max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$		
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μs	200, 320, 500, 1000	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; Gate open		
TRIGGERING						
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j\min}$ $T_j = 25\text{ }^{\circ}\text{C}$ $T_j = T_{j\max}$	$V_D = 12\text{ V}$; $I_D = 3\text{ A}$; Direct gate current	
I_{GT}	Gate trigger direct current, max	mA	400 250 150	$T_j = T_{j\min}$ $T_j = 25\text{ }^{\circ}\text{C}$ $T_j = T_{j\max}$		
V_{GD}	Gate non-trigger direct voltage, min	V	0.50	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; Direct gate current		
I_{GD}	Gate non-trigger direct current, min	mA	35.00			
SWITCHING						
t_{gd}	Delay time, max	μs	0.70	$T_j = 25\text{ }^{\circ}\text{C}$; $V_D = 600\text{ V}$; $I_{TM} = I_{TAV}$; $di/dt = 200\text{ A}/\mu\text{s}$;		
t_{gt}	Turn-on time, max	μs	3.00	Gate pulse: $I_G = 2\text{ A}$; $V_G = 20\text{ V}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt = 2\text{ A}/\mu\text{s}$		
t_q	Turn-off time ²⁾ , max	μs	125, 160, 200, 250, 320, 400, 500	$dv_D/dt = 50\text{ V}/\mu\text{s}$; $T_j = T_{j\max}$; $I_{TM} = I_{TAV}$; $di_R/dt = -10\text{ A}/\mu\text{s}$; $V_R = 100\text{ V}$; $V_D = 0.67 \cdot V_{DRM}$		
Q_{rr}	Recovered charge, max	μC	750	$T_j = T_{j\max}$; $I_{TM} = 320\text{ A}$; $di_R/dt = -10\text{ A}/\mu\text{s}$; $V_R = 100\text{ V}$		
t_{rr}	Reverse recovery time, max	μs	15			
I_{rr}	Reverse recovery current, max	A	100			

THERMAL				
R_{thjc}	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0850	Direct current
MECHANICAL				
m	Weight, max	g	520	
D_s	Surface creepage distance	mm (inch)	12.4 (4.882)	
D_a	Air strike distance	mm (inch)	12.4 (4.882)	

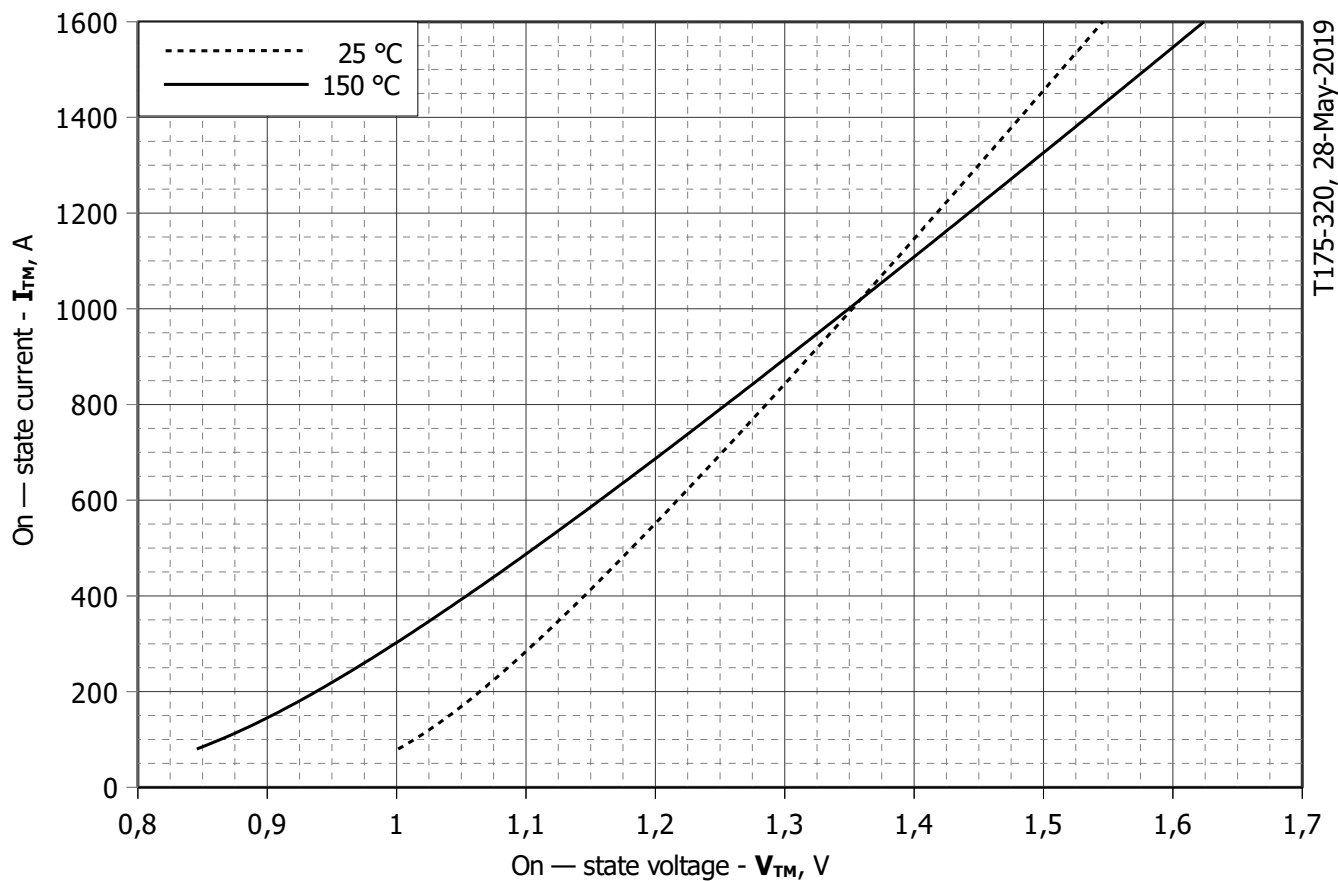
PART NUMBERING GUIDE							NOTES							
T	175	320	8	A2	E2	N								
1	2	3	4	5	6	7								
1. Phase Control Thyristor							1) Critical rate of rise of off-state voltage							
2. Design version														
3. Mean on-state current, A														
4. Voltage code														
5. Critical rate of rise of off-state voltage, V/μs														
6. Turn-off time (dv _D /dt=50 V/μs)														
7. Ambient conditions: N – normal; T – tropical														
							Symbol of Group P2 K2 E2 A2							
							(dv _D /dt) _{crit} , V/μs 200 320 500 1000							
							2) Turn-off time (dv _D /dt=50 V/μs)							
							Symbol of Group X2 T2 P2 M2 K2 H2 E2							
							t _q , μs 125 160 200 250 320 400 500							



Polarity	Example of code designation	Reference designation	Colors		
			Anode	Cathode	Gate
Anode to stud	T175-320-8		-	Red tube	White

All dimensions in millimeters (inches)

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T175-320, 28-May-2019

Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
A	0.846020000	0.61399000
B	0.000298610	0.00041869
C	0.029731000	0.04443400
D	0.000068074	0.00031045

On-state characteristic model (see Fig. 1)

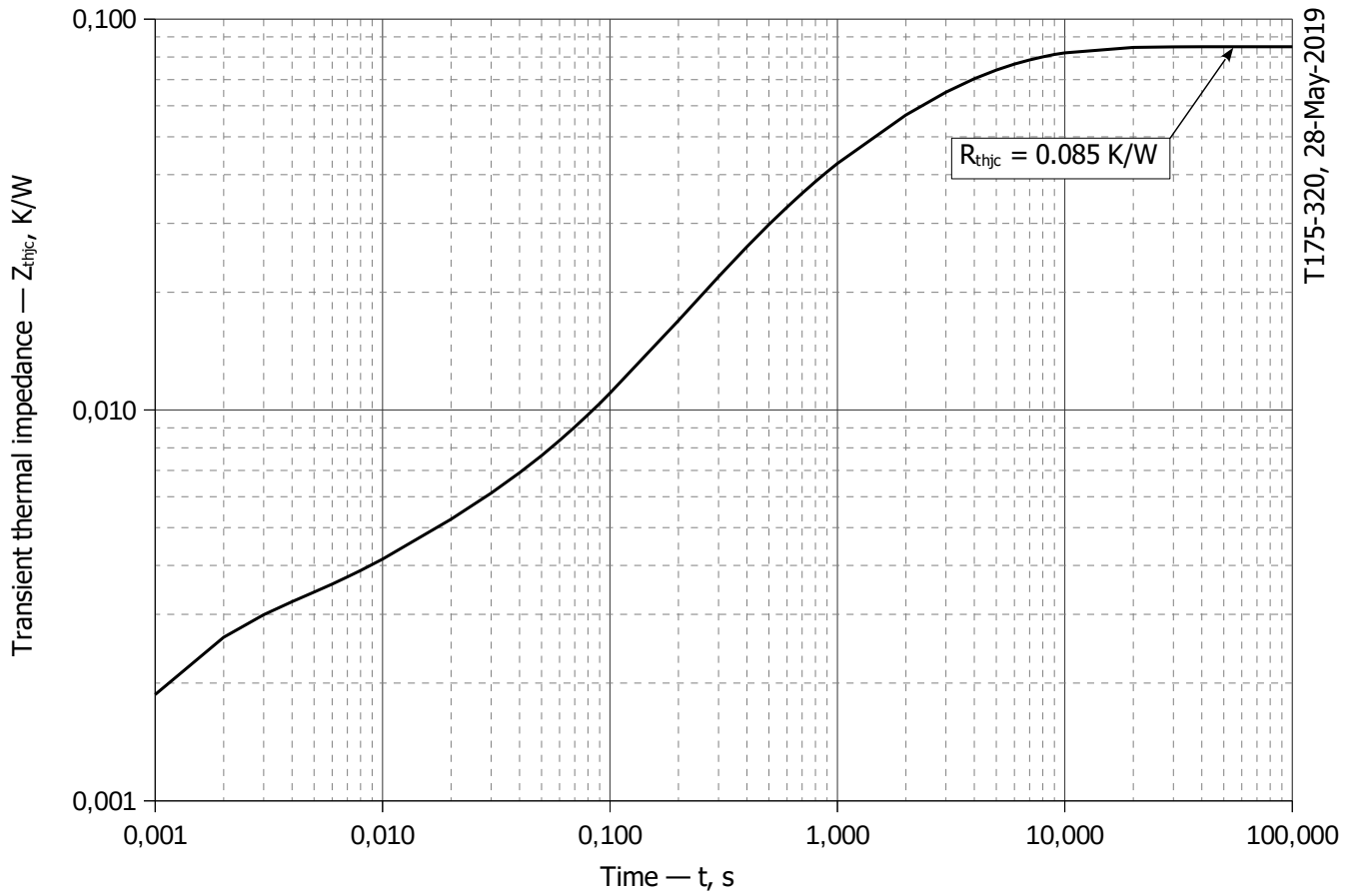


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC

i	1	2	3	4	5	6
R_i , K/W	0.023357	0.02733	0.01495	0.001445	0.002488	0.01543
τ_i , s	4.627	2.249	0.3406	0.01043	0.0009112	0.9081

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

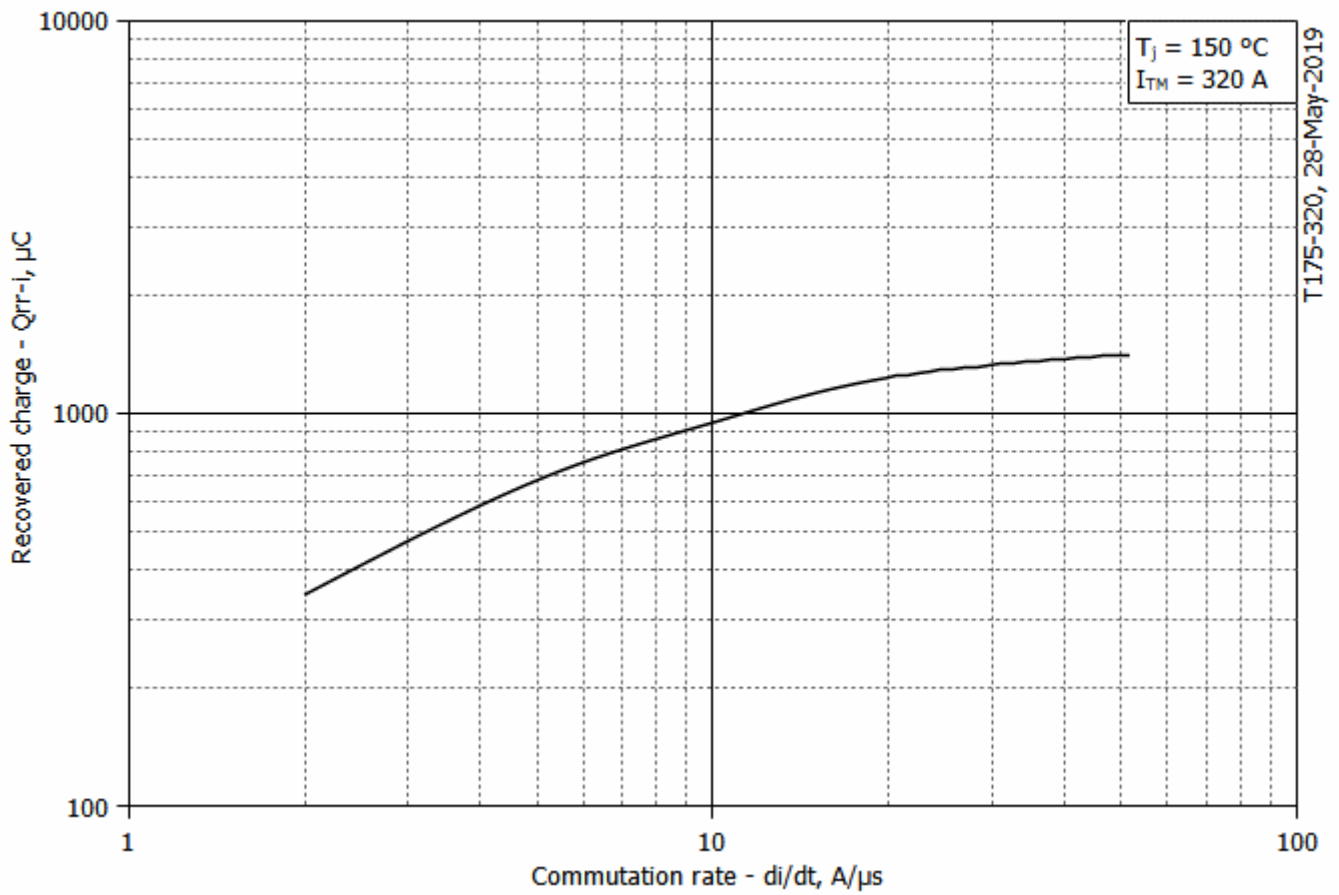


Fig 3 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

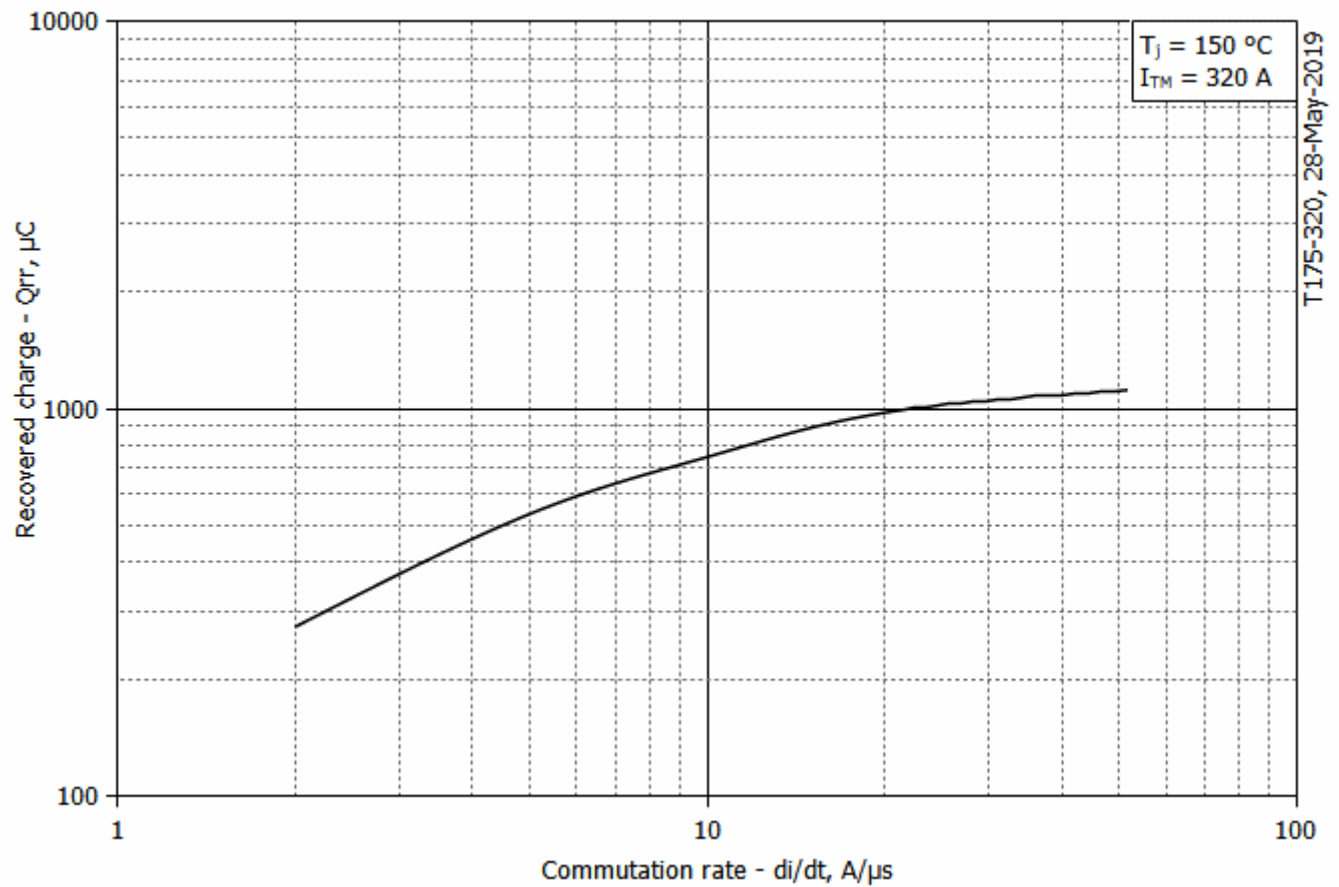


Fig 4 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

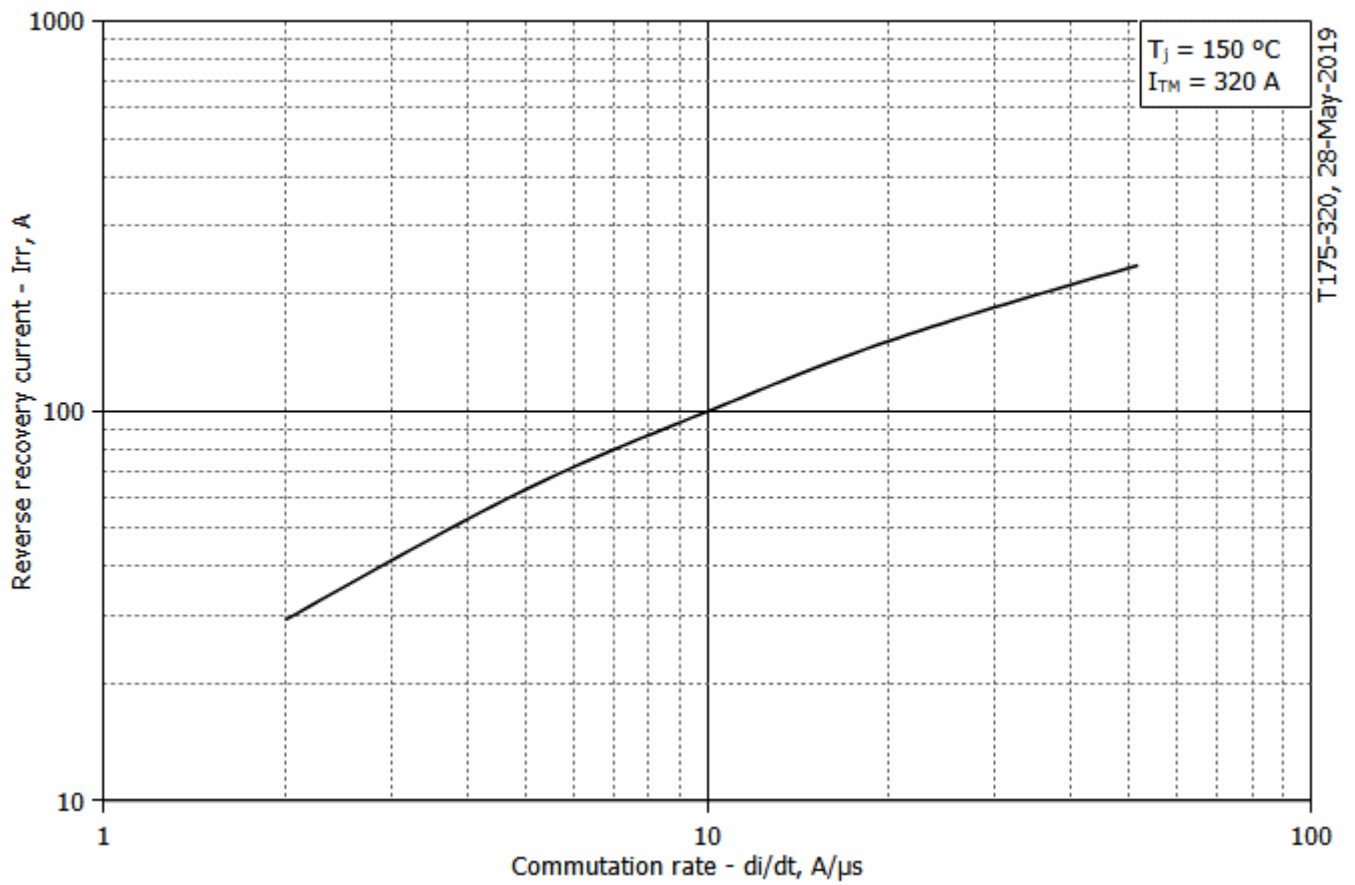


Fig 5 – Maximum reverse recovery current I_{rr} vs. commutation rate di_R/dt

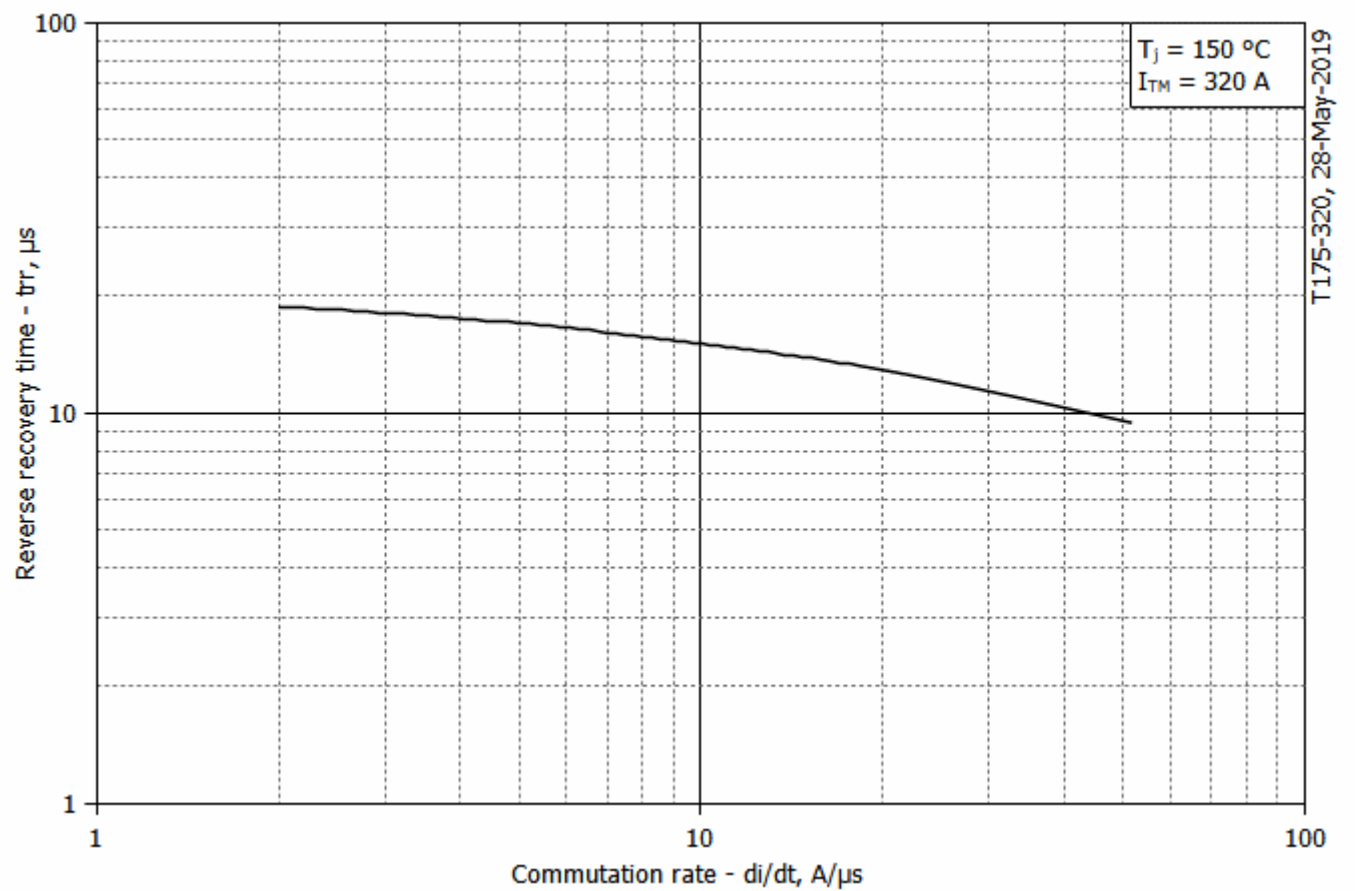
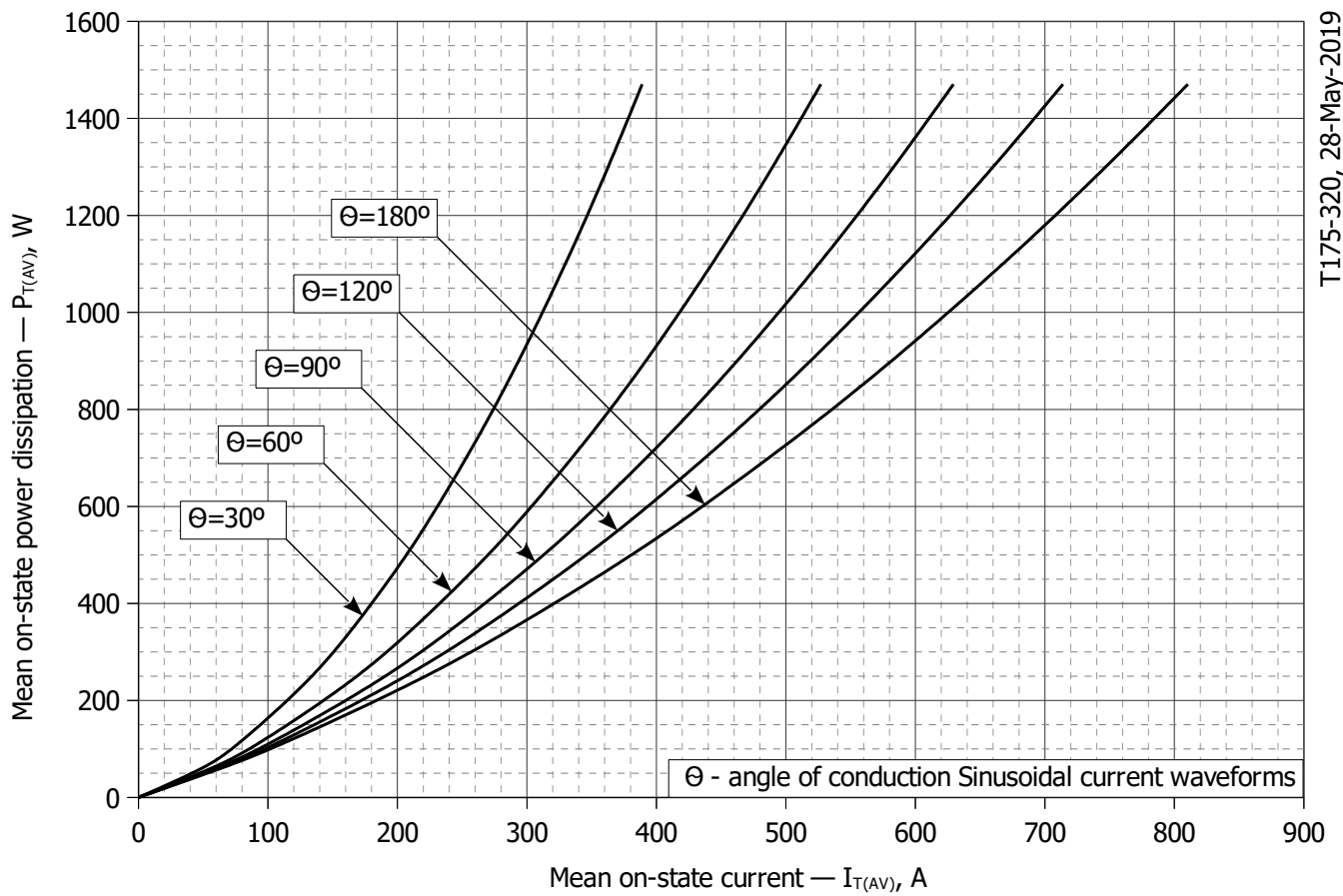
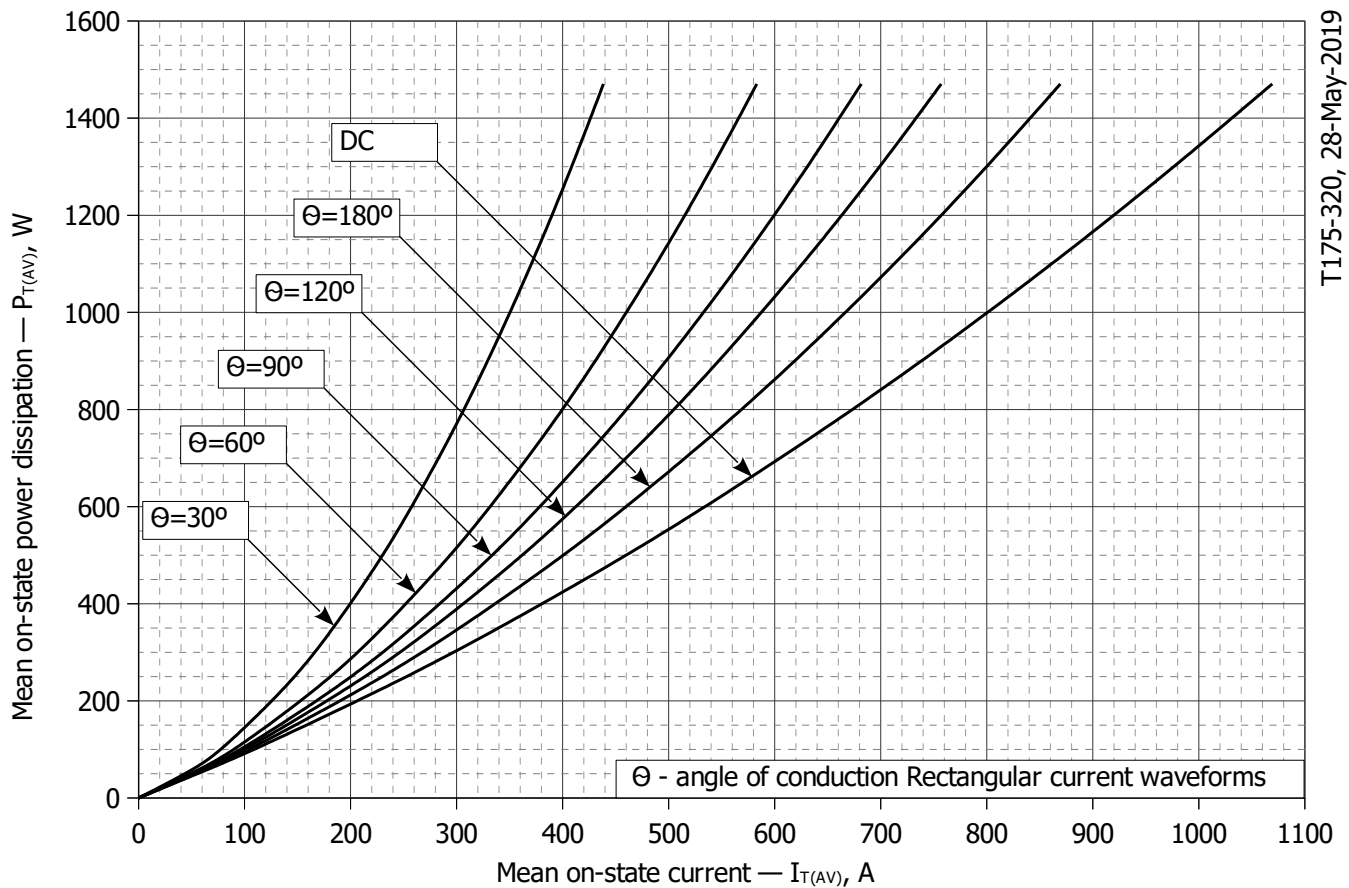


Fig 6 – Maximum recovery time t_{rr} vs. commutation rate di_R/dt (25% chord)



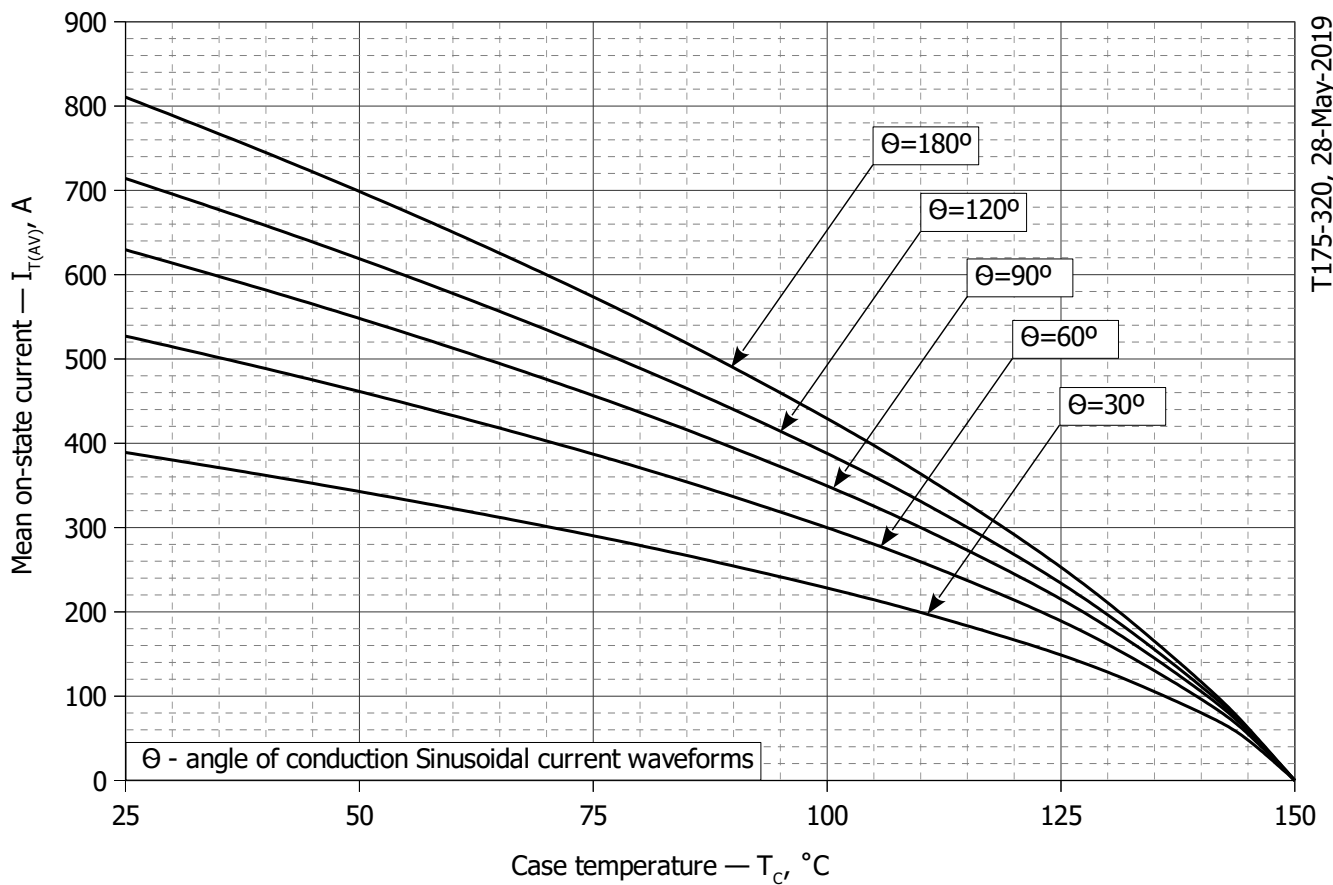
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Fig. 7 - Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$)



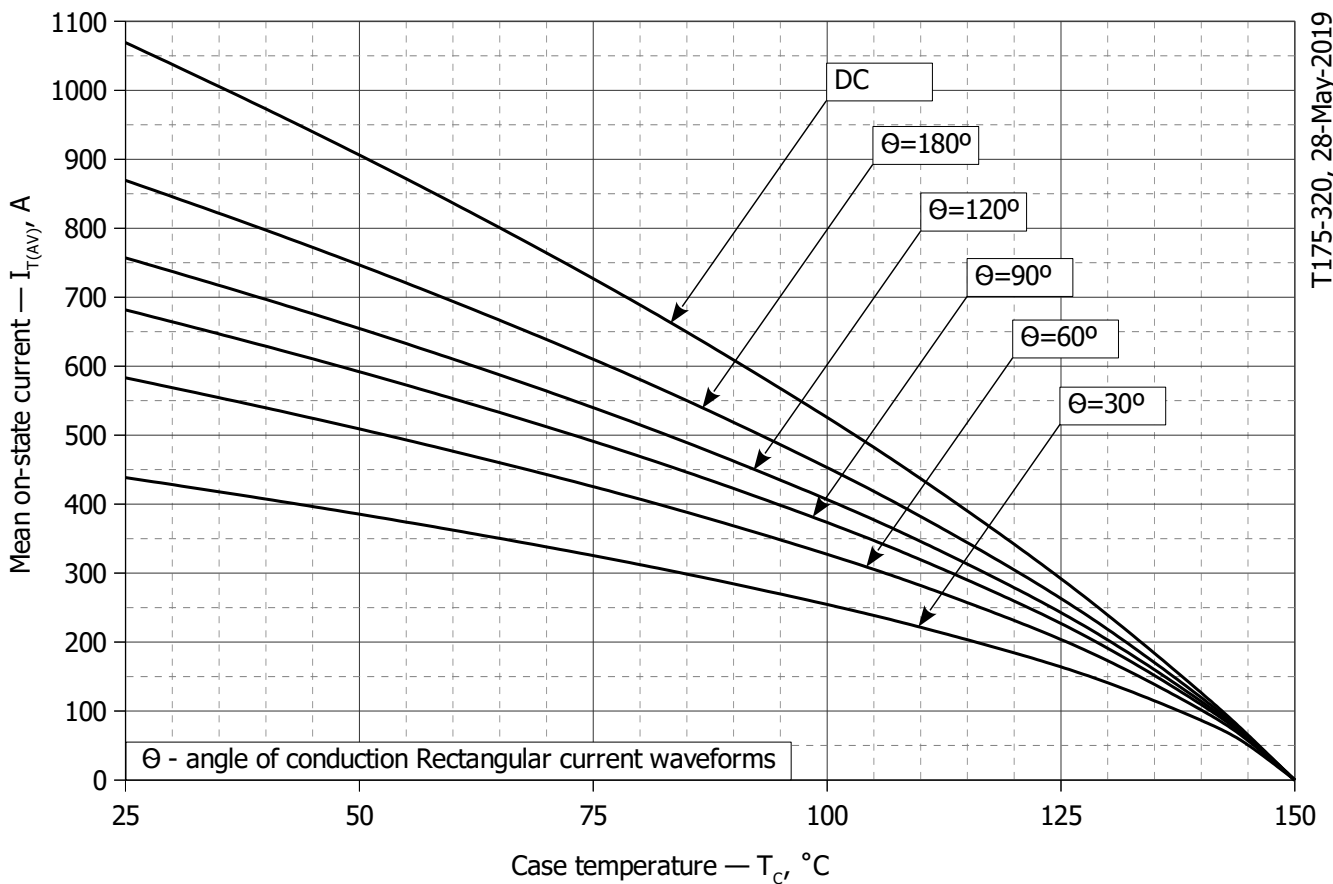
T175-320, 28-May-2019

Fig. 8 – Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$)



T175-320, 28-May-2019

Fig. 9 – Mean on-state current I_{TAV} vs. case temperature T_c for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$)



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Fig. 10 - Mean on-state current I_{TAV} vs. case temperature T_c for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$)

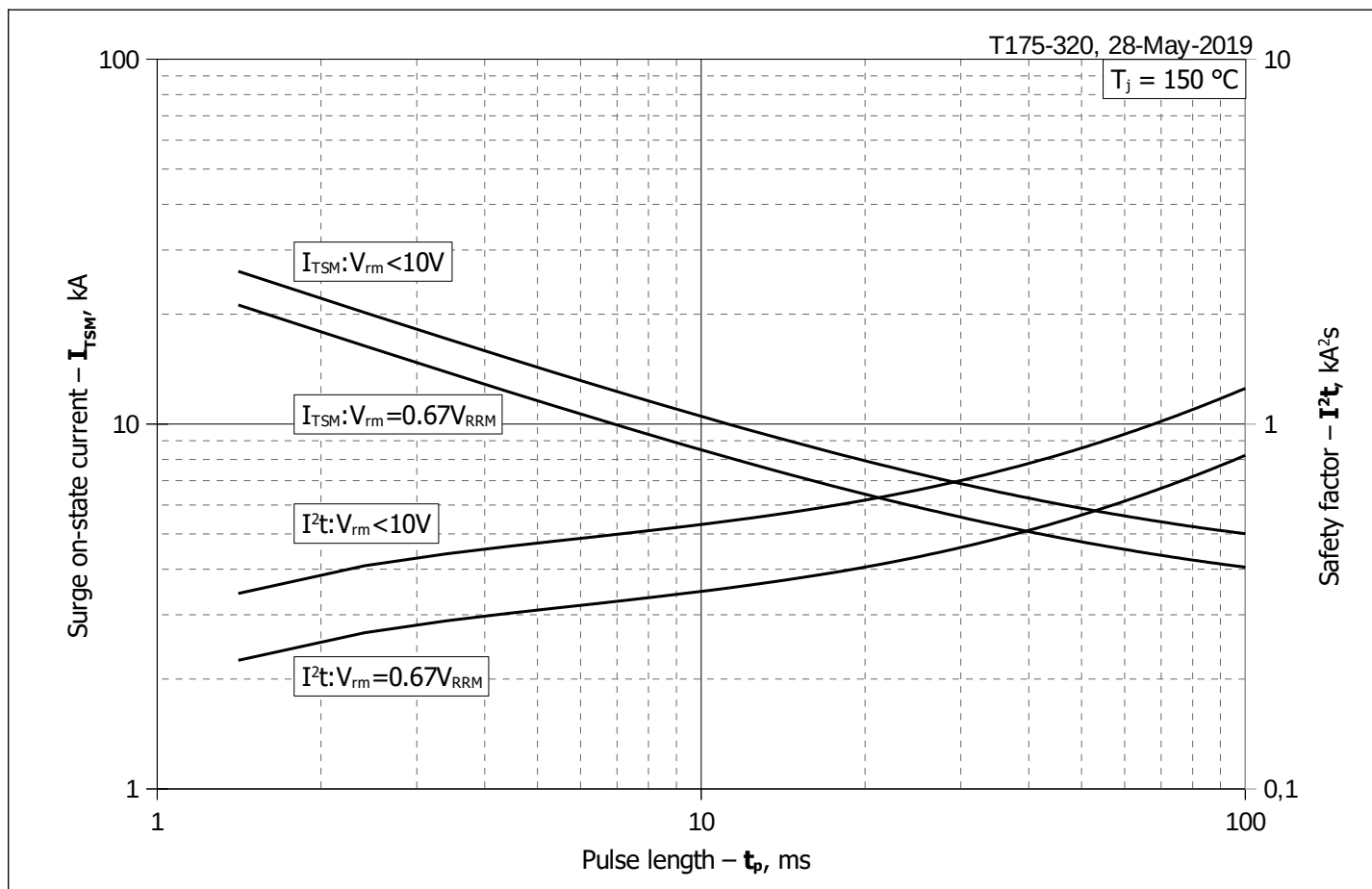


Fig. 11 – Maximum surge on-state current I_{TSM} and safety factor I^2t vs. pulse length t_p

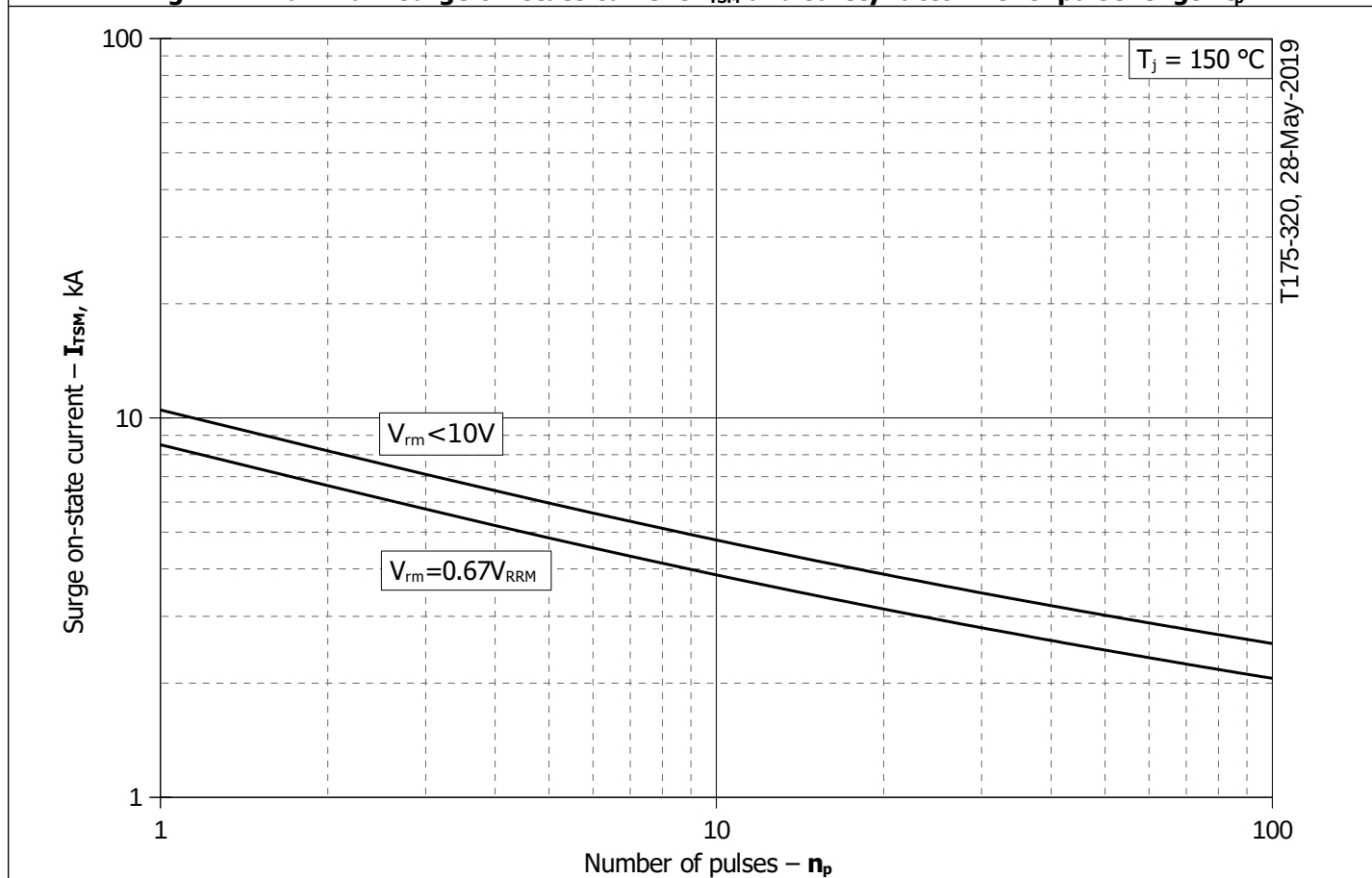


Fig. 12 - Maximum surge on-state current I_{TSM} vs. number of pulses n_p